**Preferred Device** 

# **High Current Bias Resistor Transistor**

## **PNP Silicon**

#### **Features**

• Collector -Emitter Sustaining Voltage -

 $V_{CEO(sus)} = 30 \text{ Vdc (Min)} @ I_C = 10 \text{ mAdc}$ 

• High DC Current Gain -

 $h_{FE}$  = 125 (Min) @  $I_C$  = 0.8 Adc = 90 (Min) @  $I_C$  = 3.0 Adc

• Low Collector –Emitter Saturation Voltage –

 $V_{CE(sat)} = 0.275 \text{ Vdc (Max)} @ I_C = 1.2 \text{ Adc}$ = 0.55 Vdc (Max) @ I\_C = 3.0 Adc

• SOT-223 Surface Mount Packaging

• ESD Rating – Human Body Model: Class 1B

- Machine Model: Class B

• Pb-Free Package is Available

#### **MAXIMUM RATINGS** (T<sub>C</sub> = 25°C unless otherwise noted)

Rating	Si mr ol	valu	Unit
Collector-Emitter (6) ; ge	CEC	30	Vds
Collector-Base Voltage	V <sub>CB</sub>	45	Vdc
Emitter-Base Voltage	V <sub>EB</sub>	±6.0	Vdc
Base Current – Continuous	I <sub>B</sub>	1.0	Adc
Collector Current – Continuous – Peak	Ic	3.0 5.0	Adc
Total Power Dissipation @ $T_C = 25^{\circ}C$ Derate above 25°C Total $P_D$ @ $T_A = 25^{\circ}C$ mounted on 1" sq. (645 sq. mm) Collector pad on FR-4 bd material Total $P_D$ @ $T_A = 25^{\circ}C$ mounted on 0.012" sq. (7.6 sq. mm) Collector pad on FR-4 bd material	P <sub>D</sub>	3.0 24 1.56	W mW/°C W
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

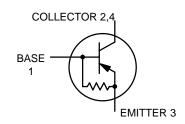
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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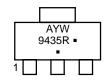
http://onsemi.com

POWER BJT  $I_C = 3.0$  AMPERES  $BV_{CEO} = 30$  VOLTS  $V_{CE(sat)} = 0.275$  VOLTS





#### MARKING DIAGRAM



A = Assembly Location

Y = Year
W = Work Week
9435R = Device Code
Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NSB9435T1	SOT-223	1000/Tape & Reel
NSB9435T1G	SOT-223 (Pb-Free)	1000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

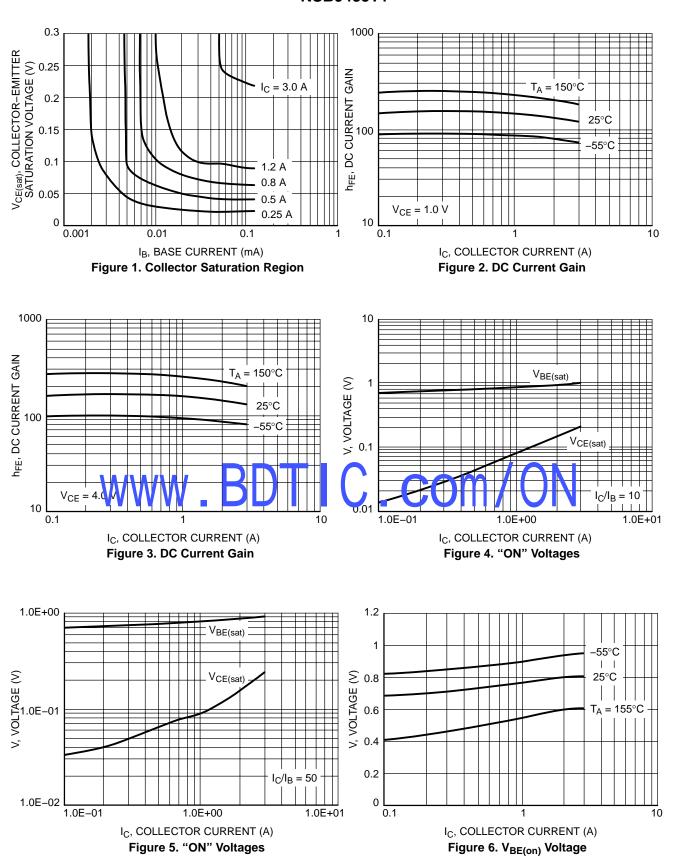
**Preferred** devices are recommended choices for future use and best overall value.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction-to-Case Junction-to-Ambient on 1" sq.(645 sq. mm) Collector pad on FR-4 board material Junction-to-Ambient on 0.012" sq. (7.6 sq. mm) Collector pad on FR-4 board material	R <sub>θJC</sub> R <sub>θJA</sub> R <sub>θJA</sub>	42 80 174	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 s	TL	260	°C

Characteristics	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage ( $I_C = 10 \text{ mAdc}, I_B = 0 \text{ Adc}$ )	V <sub>CEO(sus)</sub>	30	_	_	Vdc
Emitter–Base Voltage ( $I_E = 50 \mu Adc$ , $I_C = 0 Adc$ )	V <sub>EBO</sub>	6.0	_	_	Vdc
Collector Cutoff Current (V <sub>CE</sub> = 25 Vdc) (V <sub>CE</sub> = 25 Vdc, T <sub>J</sub> = 125°C)	I <sub>CER</sub>	- -	- -	20 200	μAdc
Emitter Cutoff Current (V <sub>BE</sub> = 5.0 Vdc)	I <sub>EBO</sub>	_	_	700	μAdc
ON CHARACTERISTICS (Note 1)					
Collector–Emitter Saturation Voltage ( $I_C = 0.8 \text{ Adc}$ , $I_B = 20 \text{ mAdc}$ ) ( $I_C = 1.2 \text{ Adc}$ , $I_B = 20 \text{ mAdc}$ ) ( $I_C = 3.0 \text{ Adc}$ , $I_B = 0.3 \text{ Adc}$ )	V <sub>CE(sat)</sub>	- - -	0.155 - -	0.210 0.275 0.550	Vdc
Base–Emitter Saturation Voltage ( $I_C = 3.0 \text{ Adc}$ , $I_B = 0.3 \text{ Adc}$ )  Base–Emitter On Voltage ( $I_C = 1.2 \text{ Adc}$ , $V_{CE} = 4.0 \text{ Vdc}$ )	V <sub>BE(sat)</sub>	0	<u>N-</u>	1.25	Vdc Vdc
DC Current Gain ( $I_C = 0.8 \text{ Adc}$ , $V_{CE} = 1.0 \text{ Vdc}$ ) ( $I_C = 1.2 \text{ Adc}$ , $V_{CE} = 1.0 \text{ Vdc}$ ) ( $I_C = 3.0 \text{ Adc}$ , $V_{CE} = 1.0 \text{ Vdc}$ )	h <sub>FE</sub>	125 110 90	220 - -	- - -	-
Resistor	R1	7.5	10	12.5	kΩ
DYNAMIC CHARACTERISTICS	•	•	•	•	•
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0 Adc, f = 1.0 MHz)	C <sub>ob</sub>	_	100	150	pF
Input Capacitance (V <sub>EB</sub> = 8.0 Vdc)	C <sub>ib</sub>	_	135	_	pF
Current-Gain - Bandwidth Product (Note 2) (I <sub>C</sub> = 500 mA, V <sub>CE</sub> = 10 V, F <sub>test</sub> = 1.0 MHz)	f <sub>T</sub>	_	110	_	MHz

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 f<sub>T</sub> = |h<sub>FE</sub>| • f<sub>test</sub>



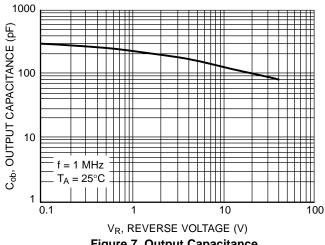


Figure 7. Output Capacitance

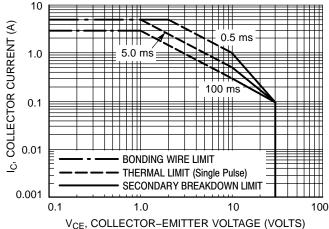


Figure 8. Active Region Safe Operating Area

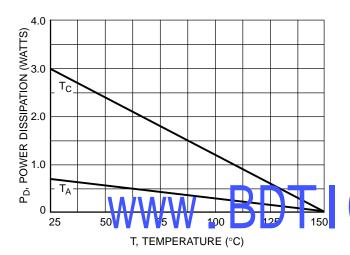


Figure 9. Power Derating

There are two limitations on the power handling ability of a transistor: average junction temperature and secondary breakdown. Safe operating area curves indicate I<sub>C</sub> – V<sub>CE</sub> limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 8 is based on  $T_{J(pk)} = 150^{\circ}C$ ;  $T_C$  is variable depending on conditions. Secondary breakdown pulse limits are valid for duty cycles to 10% provided T<sub>J(pk)</sub>  $\leq 150^{\circ}$ C.  $T_{J(pk)}$  may be calculated from the data in Figure 10. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations

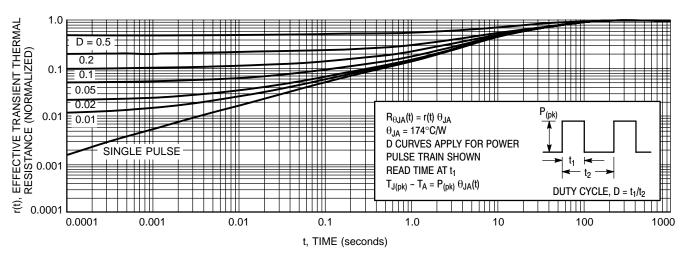
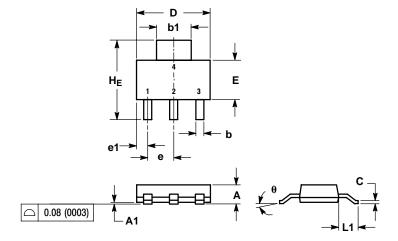


Figure 10. Thermal Response

#### PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 **ISSUE L** 



NOTES:

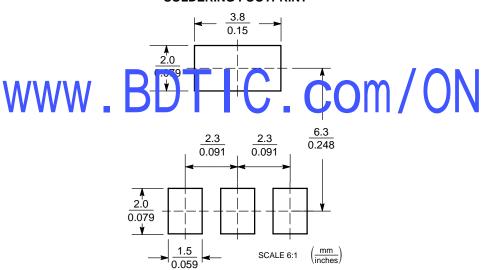
- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.50	1.63	1.75	0.060	0.064	0.068	
A1	0.02	0.06	0.10	0.001	0.002	0.004	
b	0.60	0.75	0.89	0.024	0.030	0.035	
b1	2.90	3.06	3.20	0.115	0.121	0.126	
С	0.24	0.29	0.35	0.009	0.012	0.014	
D	6.30	6.50	6.70	0.249	0.256	0.263	
E	3.30	3.50	3.70	0.130	0.138	0.145	
е	2.20	2.30	2.40	0.087	0.091	0.094	
e1	0.85	0.94	1.05	0.033	0.037	0.041	
L1	1.50	1.75	2.00	0.060	0.069	0.078	
HE	6.70	7.00	7.30	0.264	0.276	0.287	
θ	0°	-	10°	0°	-	10°	

STYLE 1: PIN 1. BASE

- COLLECTOR 3 EMITTER

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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